

June 2005 Revised August 2024

74LVT16373 • 74LVTH16373 Low Voltage 16-Bit Transparent Latch with 3-STATE Outputs

General Description

The LVT16373 and LVTH16373 contain sixteen non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable $(\overline{\text{OE}})$ is LOW. When $\overline{\text{OE}}$ is HIGH, the outputs are in a high impedance state.

The LVTH16373 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These latches are designed for low-voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT16373 and LVTH16373 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT which is maintaining a low power dissipation.

Features

- \blacksquare Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused ir (74LVTH16373), also available without bushold ture (1. 'VT16373)
- Live insertion/extraction r __mittec
- Power Up/Power Dow high hiped se provides glitch-free bus load.
- Outputs sourc 'sink ? m, 34 m/\
- Functional col atibly with the 74 series 16373
- Late Tell rmanue excepcic 500 mA
- 1 E 7 p forma...ce:

Hui n-L dy mcae! > 2000V

Machine model > 200V

Jhargad-davice model > 1000V

■ Also packaged in plastic Fine-Pitch Ball Grid Array (F3GA) (Freliminary)

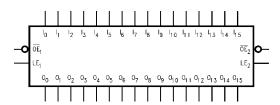
Ordering Code

Order Number	F 'umper	Package Description
74LVT163730Y	RG' 4A	54 Ball Fine-Pitch Bail Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
(Note 1)	(Preliminary)	[TAPE and REEL]
74LVT165 RMEA	MS48.A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
(Note 2)	CV	
74LVT16373M1D	iMTD48	48 Leao i nin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
(Note 2)	7	2
74LVTH16373GX	BGA54A	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
(Note 1)	(Preliminary)	[TAPE and REEL]
7/L/11/16373MEA	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
(Note 2)		
74LVTH16373MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
(Note 2)		

Note 1: BGA package available in Tape and Reel only.

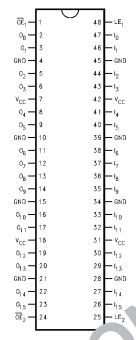
Note 2: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagrams

Pin Assignment for SSOP and TSSOP



Pin Assign for BGA



(Top Thru View)

Pin Descriptions

Pin Names	Description
OE _n	Output Enable Input (Active LOW)
LE _n	Latch Enable Input
I ₀ -I ₁₅	Inputs
O ₀ -O ₁₅	3-STATE Outputs
O ₀ -O ₁₅ NC	No Connect

FBGA Pin Assignments

	1	2	3	4	5	6
Α	O ₀	NC	OE ₁	LE ₁	NC	I ₀
В	02	O ₁	NC	NC	I ₁	l ₂
С	O ₄	O ₃	7 -	, ;	l ₃	l ₄
D	O ₆	0	GNL	G D	15	I ₆
E	O ₈	_ (_	GND	GND	17	I ₈
F	710	O ₉ 7	.vD	GN:0	l ₉	I ₁₀
G	L C 2	1	Vcc	Vcc	I ₁₁	I ₁₂
	O ₁₄	ار 13	NC	NC	I ₁₃	I ₁₄
	15	NC	ŌE ₂	LE ₂	NC	I ₁₅

Tight Tables

SH.	inputs	144.	Outputs
LE ₁ O	QE,	I ₀ -I ₇	0 ₀ -0 ₇
X	H	Х	Z
1/D/	L	L	L
Н	L	Н	н
L	L	Х	O _o

	Inputs				
LE ₂	\overline{OE}_2	I ₈ –I ₁₅	O ₈ -O ₁₅		
Х	Н	Х	Z		
Н	L	L	L		
Н	L	Н	Н		
L	L	Χ	O _o		

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial Z = HIGH Impedance

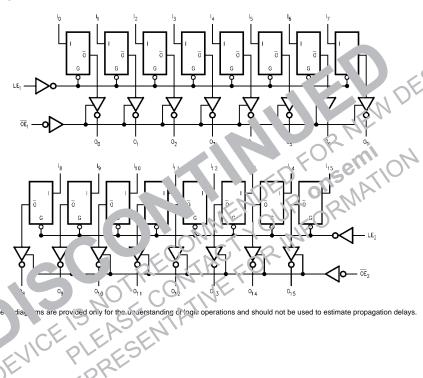
 O_0 = Previous output prior to HIGH-to-LOW transition of LE

Functional Description

The LVT16373 and LVTH16373 contain sixteen D-type latches with 3-STATE standard outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the $\mathbf{D}_{\mathbf{n}}$ enters the latches. In this condition the latches are transparent, i.e, a latch output will change states each time its D input changes. When LE_n is LOW,

the latches store information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LEn. The 3-STATE standard outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW, the standard outputs are in the 2-state mode. When $\overline{\text{OE}}_n$ is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagrams



 I_{CC}

 I_{GND}

 $\mathsf{T}_{\mathsf{STG}}$

Absolute Maximum Ratings(Note 3) Parameter Symbol Value Conditions Units Supply Voltage -0.5 to +4.6 ٧ VI DC Input Voltage -0.5 to +7.0 Vo DC Output Voltage -0.5 to +7.0 Output in 3-STATE ٧ Output in HIGH or LOW State (Note 4) -0.5 to +7.0 DC Input Diode Current -50 $V_I < GND$ mΑ I_{IK} V_O < GND I_{OK} DC Output Diode Current -50 mΑ DC Output Current 64 $V_O > V_{CC}$ Output at HIGH State

128

±64

±128

-65 to +150

mΑ

mΑ

°C

Output at LOW State

Recommended Operating Conditions

DC Supply Current per Supply Pin

Storage Temperature

DC Ground Current per Ground Pin

Symbol	Parameter	in	Max	Units
V _{CC}	Supply Voltage	27	3.6	V
VI	Input Voltage	0	5.5	V
I _{OH}	HIGH Level Output Current	24	-32	mA
I _{OL}	LOW Level Output Current		64	mA
T _A	Free-Air Operating Temperature	-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = V	390	10	ns/V

Note 3: Absolute Maximum continuous ratings are those values. Yound who damage to fine levice may or acc. Exposure to in-seconditions or conditions beyond those indicated may adversely affect device reliation and open in on under absolute maximum rated conditions is not implied.

Note 4: Io Absolute Maximum Rating must be obtained.

DC Electrical Charac rists

Symbol	vramet		V _C (T _A = 40°C to		to +85°C Units		Conditions
Cynnbon	Tamet	RV	(/0)	Min	Max	Onito	Conditions
V _{IK}	Inp † Ci Voltage	<u> </u>	2.7		-1.2	V	I _I = -18 mA
V _{IH}	Inpu 'IGH Volta'		2.7-3.8	2.0		V	V _O ≤ 0.1V or
V _{IL}	i. It L V Voitage	CK	2. <i>i</i> -3.6		0.8	V	$V_O \ge V_{CC} - 0.1V$
V _{OH}	Ou Jt HiGH Voltage	111.	2.7–3.6	V _{CC} - 0.2			I _{OH} = -100 μA
			2.7	2.4		V	I _{OH} = -8 mA
		65	3.0	2.0			I _{OH} = -32 mA
V _{OL}	Cuiput LOW Voltage		2.7		0.2		I _{OL} = 100 μA
G)	281		2.7		0.5		I _{OL} = 24 mA
1/2	QL.		3.0		0.4	V	I _{OL} = 16 mA
KI.			3.0		0.5		$I_{OL} = 32 \text{ mA}$
•			3.0		0.55		I _{OL} = 64 mA
I _{I(HOLD)}	Bushold Input Minimum Drive		3.0	75		μА	V _I = 0.8V
(Note 5)			5.0	-75		μΑ	V _I = 2.0V
I _{I(OD)}	Bushold Input Over-Drive		3.0	500		μА	(Note 6)
(Note 5)	Current to Change State		0.0	-500		μ	(Note 7)
l _l	Input Current		3.6		10		V _I = 5.5V
		Control Pins	3.6		±1	μА	$V_I = 0V \text{ or } V_{CC}$
		Data Pins	3.6		-5	μ	$V_I = 0V$
		Data i ilis	5.0		1		$V_I = V_{CC}$
l _{OFF}	Power Off Leakage Current		0		±100	μΑ	$0V \le V_I \text{ or } V_O \le 5.5V$
I _{PU/PD}	Power Up/Down 3-STATE Output Current		0-1.5V		±100	μА	V _O = 0.5V to 3.0V
			0-1.5		±100	μΛ	$V_I = GND \text{ or } V_{CC}$
I _{OZL}	3-STATE Output Leakage Current		3.6		-5	μΑ	V _O = 0.5V
I _{OZH}	3-STATE Output Leakage Curre	ent	3.6		5	μΑ	V _O = 3.0V
I _{OZH} +	3-STATE Output Leakage Curre	ent	3.6		10	μΑ	$V_{CC} < V_O \le 5.5V$

DC Electrical Characteristics (Continued)

Symbol	Parameter	V_{CC} $T_A = -40^{\circ}C \text{ to } +8$		C to +85°C	Units	Conditions	
- Cymbol	T didilicio	(V)	Min	Max	O.I.I.S	Conditions	
I _{CCH}	Power Supply Current	3.6		0.19	mA	Outputs HIGH	
I _{CCL}	Power Supply Current	3.6		5	mA	Outputs LOW	
I _{CCZ}	Power Supply Current	3.6		0.19	mA	Outputs Disabled	
I _{CCZ} +	Power Supply Current	3.6		0.19	mA	$V_{CC} \le V_O \le 5.5V$,	
						Outputs Disabled	
ΔI_{CC}	Increase in Power Supply Current	3.6		0.2	mA	One Input at V _{CC} – 0.6V	
	(Note 8)					Other Inputs at V _{CC} or GND	

Note 5: Applies to bushold versions only (74LVTH16373).

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

 $\textbf{Note 8:} \ \text{This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.}$

Dynamic Switching Characteristics (Note 9)

Symbol	Symbol Parameter		V _{CC}			Conuitions
Cymbo.	T drameter	(V)	Min	Тур	Max	$C_L = 50 \text{ pF}, R_L = 500\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		(Note 10)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8		V (Note 10)

Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

AC Electrical Characteristics

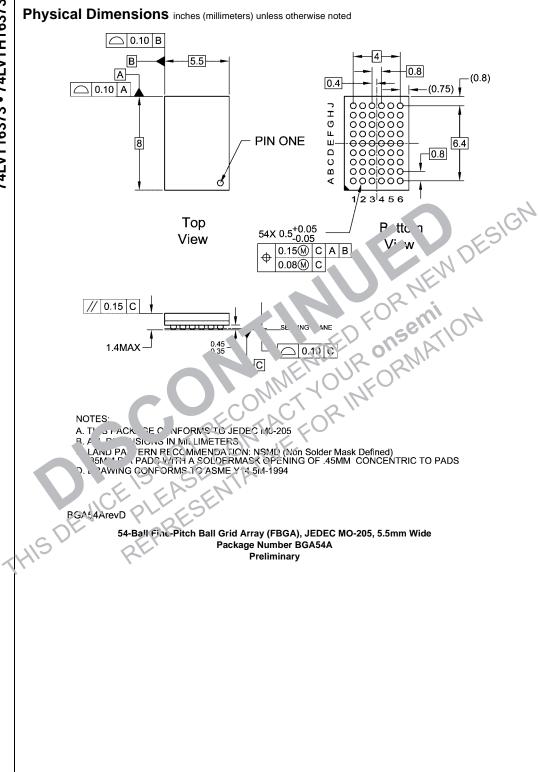
	$T_A = -40^{\circ}\text{C}$, $c_L = 0^{\circ}\text{C}$, $C_L = 0^{\circ}\text{DF}$, $R_L = 0.00$						
Symbol	Parameter	-cc = 3.3	3 V ± 0.3V	V _C ;	= 2.7V	Units	
		Mir.	Mia:	N.(n	Max		
t _{PHL}	Propagation Delay	1.5	3.9	1.5	4.3	ns	
t _{PLH}	D _n to O _n	1.5	3.8	1.5	4.2	113	
t _{PHL}	Propagati Duay	1.9	1.2	1.9	4.4	ns	
t _{PLH}	LE+ On	1.6	4.3	1.6	4.8	115	
t _{PZL}	Outpu Fnable Tim	1.3	4.3	1.3	4.9	ns	
t _{PZH}	S CK	1.0	4.3	1.0	5.1	115	
t _{PLZ}	Out Disable Time	1.5	4.7	1.5	4.8	ns	
t _{PHZ}		2.0	5.0	2.0	5.4	115	
t _S	Setup Time, Un to Life	1.0		0.8		ns	
t _H	Hola Time, D _n to LE	1.0		1.1		ns	
t _W	LT Pulse Width	3.0		3.0		ns	
toshl	Output to Output Skow (Note 11)		1.0		1.0	ns	
tosijh			1.0		1.0	113	

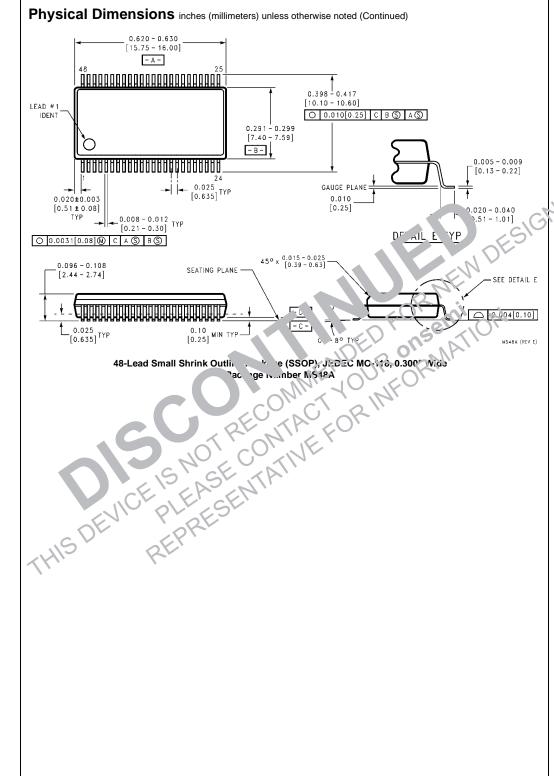
Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

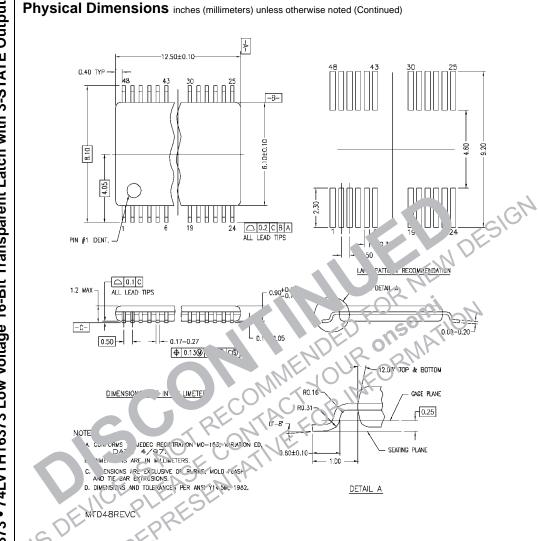
Capacitance (Note 12)

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	V _{CC} = Open, V _I = 0V or V _{CC}	4	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.0V$, $V_{O} = 0V$ or V_{CC}	8	pF

 $\textbf{Note 12:} \ \textbf{Capacitance is measured at frequency } \textbf{f} = \textbf{1 MHz}, \textbf{per MIL-STD-883}, \textbf{Method 3012}.$







48-Lea 17 hin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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